

U.S. PTO  
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U.S. DEPARTMENT OF COMMERCE  
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Form PTO-1  
OMB No. 08:

07-23-2007



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FORM COVER SHEET  
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To the D.

Use record the attached documents or the new address(es) below.

1. Name of conveying party(ies):  
Jaemyoung Jhung  
  
Additional name(s) of conveying party(ies) attached?  Yes  No

2. Name and address of receiving party(ies)  
Name: MEMS SOLUTION INC.  
4F, B1 Institute for Advanced Engineering  
Internal Address:  
Street Address:  
  
P.O. Box 25, 633-2, Goan-ri, Baekam-myeon,  
  
City: Yongin-si  
Province: Gyeonggi-do  
Country: Republic of Korea Zip: 449-860  
Additional name(s) & address(es) attached?  Yes  No

3. Nature of conveyance/Execution Date(s):  
Execution Date(s): July 2, 2007  
 Assignment  Merger  Change of Name  
 Security Agreement  Joint Research Agreement  
 Government Interest Assignment  
 Executive Order 9424, Confirmatory License  
 Other

4. Application or patent number(s):  This document is being filed together with a new application.  
A. Patent Application No.(s)  
This application  
  
Additional numbers attached?  Yes  No

B. Patent No.(s)  
  
11/826332  
 Yes  No

5. Name and address to whom correspondence concerning document should be mailed:  
Name: Robert H. Berdo, Jr.  
RABIN & BERDO, PC  
Internal Address: Atty. Dkt.: JUN-136  
Street Address: 1101 14th St., NW  
Suite 500  
  
City: Washington  
State: DC Zip: 20005  
Phone Number: (202) 371-8976  
Fax Number: (202) 408-0924  
Email Address: firm@rabinberdo.com

6. Total number of applications and patents involved: 1  
  
7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00  
 Authorized to be charged by credit card  
 Authorized to be charged to deposit account  
 Enclosed  
 None required (government interest not affecting title)

8. Payment Information  
a. Credit Card Last 4 Numbers 4591  
Expiration Date 08/31/07  
b. Deposit Account Number  
Authorized User Name

9. Signature:   
Signature Date July 13, 2007  
Robert H. Berdo, Jr. - 38,075  
Name of Person Signing  
Total number of pages including cover sheet, attachments, and documents: 2

7-13-07

07/16/2007 SZEUDIE1 00000056 11826332  
04 FC:8021 (40.00 OP)

**ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT**

WHEREAS JHUNG, Jaemyoung hereinafter referred to collectively as the assignor, has invented a certain improvement relating to

Piezoelectric microphone,

[ x ] the inventor(s) declaration for said application being executed concurrently with the execution of this instrument; said application to be filed in the United States Patent and Trademark Office;  
[ ] said application having been filed in the United States Patent and Trademark Office on \_\_\_\_\_, authorization being hereby given to my attorneys, Steven M. Rabin, Robert H. Berdo, Jr., Phillip G. Avruch, and Allen Wood of RABIN & BERDO, P.C., 1101 14th Street, N.W., Washington, D.C. 20005, to insert here in parentheses (Application Serial No. \_\_\_\_\_) the application serial number of said application when known;

AND WHEREAS MEMS SOLUTION INC. of 4F, B1 Institute for Advanced Engineering, P.O.Box 25, 633-2, Goan-ri, Baekam-myeon, Yongin-si, Gyeonggi-do 449-860 Republic of Korea hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

EXECUTED, this 2nd day of July, 2007.

**WITNESSES:**

Signature: \_\_\_\_\_

Name: PARK, Woong

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Signature: \_\_\_\_\_

Name: JUNG, Se-Sung

Address: #11<sup>th</sup> FL, Hyundai Jeonwon Officetel, 1589-7, Seocho-dong, Seocho-gu, Seoul 137-070, KOREA

RABIN & BERDO, P.C., Washington, D.C.

**ASSIGNOR:**

Signature: \_\_\_\_\_

Name: JHUNG, Jaemyoung

**PATENT**